



DMTH6015LPDW

60V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C	
60V	20mΩ @ V _{GS} = 10V	36.3A	
	27mΩ @ V _{GS} = 4.5V	31.2A	

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- · Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

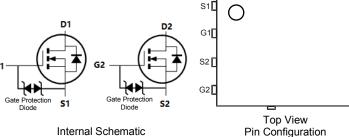
This new generation N-channel enhancement mode MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- Wireless Charging
- DC-DC Converters
- Power Management

Mechanical Data

- Case: PowerDI[®] 5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Lead-Frame;
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





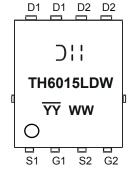
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6015LPDW-13	PowerDI5060-8/SWP (Type UXD)	2,500 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TH6015LDW = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 20 = 2020)
WW = Week Code (01 to 53)

D1

] D1 ∏ D2

7 D2



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±16	V		
Continuous Drain Current, V_{GS} = 10V (Note 6) $T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$			I _D	36.3 25.6	Α
Continuous Drain Current, V _{GS} = 10V (Note 5) Steady State		$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	I _D	9.4 6.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	140	Α		
Maximum Continuous Body Diode Forward Current (Note 5)	I _S	35	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle	I _{SM}	140	Α		
Avalanche Current L = 0.1mH	I _{AS}	20.4	Α		
Avalanche Energy L = 0.1mH			Eas	20.8	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	2.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	57	°C/W
Total Power Dissipation (Note 6)	P _D	39.5	W	
Thermal Resistance, Junction to Case (Note 6)	Rejc	3.8	°C/W	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1.3	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	14.3	20	mΩ	V _{GS} = 10V, I _D = 10A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	19.2	27	11112	V _{GS} = 4.5V, I _D = 6A	
Diode Forward Voltage	V_{SD}		0.7	1.2	V	V _{GS} = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 8)			•	•	•	•	
Input Capacitance	Ciss	_	825	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	244	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	20.5	_			
Gate Resistance	R _G	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qq	_	7.1	_			
Total Gate Charge (V _{GS} = 10V)	Qq	_	14.3	_		V 20V I 40A	
Gate-Source Charge	Q _{gs}	_	2.1	_	nC	$V_{DS} = 30V, I_{D} = 10A$	
Gate-Drain Charge	Q_{ad}		2.8	_			
Turn-On Delay Time	t _{D(ON)}	_	4.0	_			
Turn-On Rise Time	t _R	_	5.3	_		$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	18.5	_	ns	$R_G = 6\Omega$, $I_D = 10A$	
Turn-Off Fall Time	t _F	_	8.0	_			
Reverse Recovery Time	t _{RR}	_	22.7	_	ns		
Reverse Recovery Charge	Q _{RR}	_	12.8	_	nC	I _F = 6A, di/dt = 100A/μs	

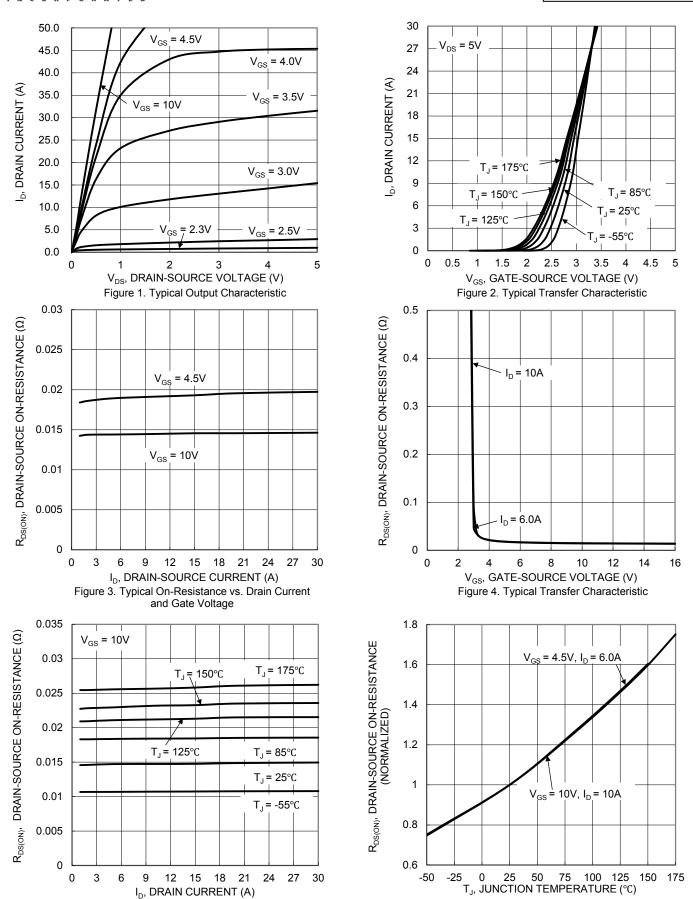
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.









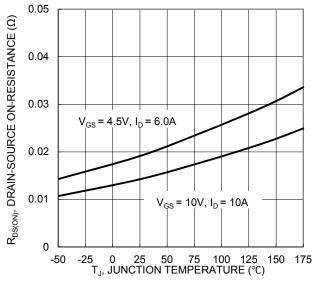


Figure 7. On-Resistance Variation with Junction Temperature

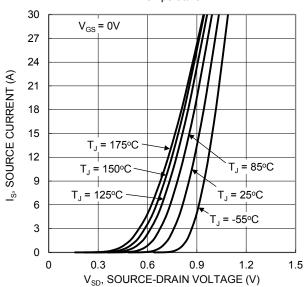


Figure 9. Diode Forward Voltage vs. Current

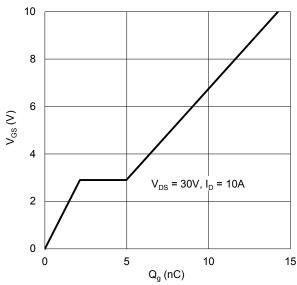


Figure 11. Gate Charge

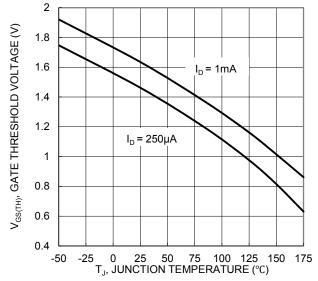


Figure 8. Gate Threshold Variation vs. Junction Temperature

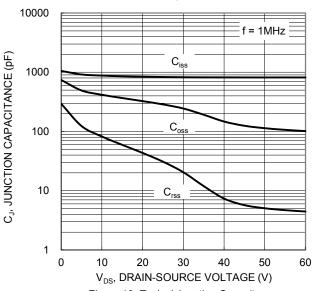
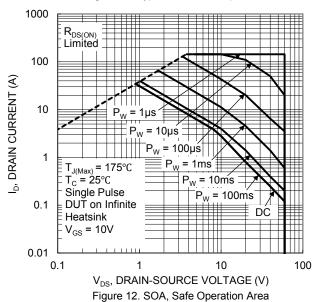


Figure 10. Typical Junction Capacitance



4 of 7 www.diodes.com



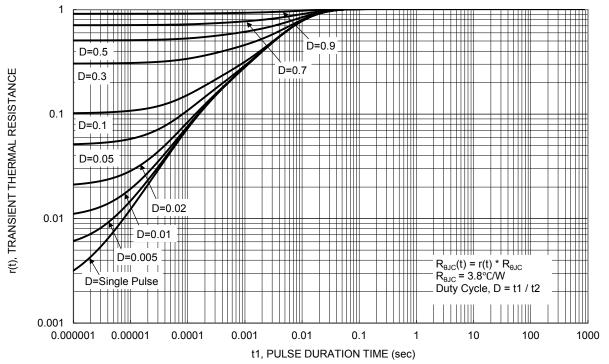


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD) 1.900 01.000 Depth 0.07±0.030 DETAIL A

PowerDI5060-8/SWP						
	(Type UXD)					
Dim	Min Max		Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF				
С	0.230	0.330	0.277			
D	5	.15 BS0	\sim			
D1	4.70	5.10	4.90			
D2	1.46	1.66	1.55			
D3	3.78	3.78 4.18 3.98				
Е	6	.40 BS0	C			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	1.27BSC				
k	1.05		-			
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
M	3.205	4.005	3.605			
W	0.025	0.225	0.125			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Seating Plane

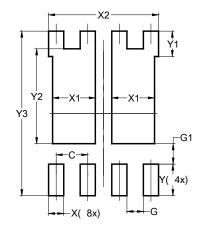
DETAIL A

Suggested Pad Layout

E3

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

PowerDI5060-8/SWP (Type UXD)



Dimensions	value		
פווטופווסוטווס	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	1.720		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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